

PATENT ASSIGNMENT

Electronic Version v1.1

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Shur-Fen Liu	12/29/2008
Meng-Huei Chen	12/29/2008
Man-Chun Yu	12/29/2008
RECEIVING PARTY DATA	
Name:	INDUSTRIAL TECHNOLOGY RESEARCH INSTITUTE
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12344484
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ATTORNEY DOCKET NUMBER:	0954-A22482-US
NAME OF SUBMITTER:	C. David Pai
Total Attachments: 1 source=0954-A22482-US_Assign#page1.tif	

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**PATENT
REEL: 022152 FRAME: 0467**

ASSIGNMENT

WHEREAS, Shur-Fen LIU, Meng-Huei CHEN and Man-Chun YU hereafter referred to as ASSIGNOR, has/have invented certain new and useful improvements as described and set forth in the below identified application for United States Letters Patent:

Title: FLEXIBLE, LOW DIELECTRIC LOSS COMPOSITION AND METHOD FOR PREPARING THE SAME
Filed: 2008/12/27 Serial No. 12/344,484
Executed on: 2008/12/29 and 2008/12/29 and 2008/12/29

WHEREAS, Industrial Technology Research Institute of No. 195, Sec. 4, Chung Hsing Rd., Chung Hsinchu 31040, Taiwan, R. O. C. hereinafter referred to as ASSIGNEE, is desirous of acquiring ASSIGNOR'S interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by Assignor, Assignor has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said Assignor had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

Assignor further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

IN TESTIMONY WHEREOF, Assignor has/have signed his/her/their name(s) on the date(s) indicated.

Shur-Fen Liu

Shur-Fen LIU

2008. 12. 29

Date:

Meng-Huei Chen

Meng-Huei CHEN

2008. 12. 29

Date:

Man-chun Yu

Man-Chun YU

2008 - 12. 29

Date:

PATENT